

惠州市鑫永诚光电科技有限公司 Huizhou Newopto photoelectric Technology Co., Ltd.

# 产品承认书

# SPEC FOR APPROVAL

| 产品型号<br>Model | XYC-RM6BA38L |
|---------------|--------------|
| 承认编号          |              |
| Part No.      |              |
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| 客户确认(Customer Signatures) |  |  |  |
|---------------------------|--|--|--|
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|                           |  |  |  |

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#### • Description

The XYC-RM6BA38L is miniaturized infrared receivers for remote control and other applications requiring improved ambient light rejection.

The separate PIN diode and preamplifier IC are assembled on a single lead frame. The epoxy package contains a special IR filter. This module has excellent performance even in disturbed ambient light applications and provides protection against uncontrolled output pulses.

#### Features

- No External Components Except Pin Diode.
- supply voltage 2.7V to 5.5V
- Internal filter for a high frequency lighting fluorescent lamp
- Output active low
- Carrier Frequency 36kHz to 40 kHz. available
- 43mil /26mil small size photo diode is available

#### Applications:

- 1. Optical switch
- 2. Light detecting protion of remote contol
  - AV instruments such as Audio, TV, VCR, CD, MD, DVD, etc.
  - Home appliances such as Air-conditioner, Fan, etc.
  - CATV set top boxes
  - Multi-media Equipment
  - •

#### • Absolute Maximum Ratings(Ta=25°C)

| Parameter             | Symbol | Ratings   | Unit | Notice                             |
|-----------------------|--------|-----------|------|------------------------------------|
| Supply Voltage        | Vcc    | 2.7 – 5.5 | V    | _                                  |
| Operating Temperature | Topr   | -20~+85   | °C   |                                    |
| Storage Temperature   | Tstg   | -40~+85   | °C   | _                                  |
| Soldering Temperature | Tso1   | 260       | °C   | 4mm from mold body less than 5 sec |

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#### • Electrical And Optical Characteristics(Ta=25C°)

| Deremeter                 | Symbol         | Ratings |      | 11   | 0    |                    |
|---------------------------|----------------|---------|------|------|------|--------------------|
| Parameter                 | Symbol         | Min.    | Тур. | Max. | Unit | Condition          |
| Supply Voltage            | Vs             | 2.7     |      | 5.5  | V    |                    |
| Supply Current            | lcc            |         | 0.2  | 0.30 | mA   | No signal input    |
|                           | L <sub>0</sub> | 16      | _    | _    | — m  |                    |
| Reception Distance        | $L_{45}$       | 8       |      |      |      | At the ray axis*1  |
| B.P.F Center Frequency    | fo             |         | 38   |      | KHz  |                    |
| Peak Wavelength           | λр             |         | 940  | _    | nm   |                    |
| Half Angle                | θ              |         | 45   | _    | deg  | At the ray axis *1 |
| High Level Pulse Width    | Т <sub>н</sub> | 500     |      | 800  | μS   | At the ray axis *2 |
| Low Level Pulse Width     | ΤL             | 500     | _    | 800  | μS   |                    |
| High Level Output Voltage | Vн             | 2.7     | 3.0  | _    | V    |                    |
| Low Level Output Voltage  | VL             |         | 0.2  | 0.4  | V    |                    |

\*1:The ray receiving surface at a vertex and relation to the ray axis in the range of  $\theta=0^{\circ}$  and  $\theta=45^{\circ}$ \*2:A range from 30cm to the arrival distance. Average value of 50 pulses

#### BLOCK DIAGRAM



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# INFRARED RECEIVER MODULE XYC-RM6BA38L

- Test Method
  - A. Standard Transmitter





B. Detection Length Test



C. Pulse Width Test

Transmitter Output



D. U.T Output Pulse



Application Circuit





# INFRARED RECEIVER MODULE XYC-RM6BA38L

#### • Package Dimensions:



#### NOTES:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.30 \text{mm}$  (0.012") unless otherwise specified.
- 3. Specifications are subject to change without notice

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#### • Electrical And Optical Curves(Ta=25°C)



Fig.3 Frequency Dependence of Responsivity











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# INFRARED RECEIVER MODULE XYC-RM6BA38L

#### Acceptable code list

| Data Format | Code Acceptable |
|-------------|-----------------|
| NEC         | 0               |
| RC5_Philips | 0               |
| RC6_Philips | 0               |
| RCA_Thomson | X               |
| Toshiba     | 0               |
| Sharp       | 0               |
| Sony 12 Bit | 0               |
| Sony 15 Bit | X               |
| Sony 20 Bit | X               |
| XMP/RCMM    | X               |

#### 包装规格 Packing Specification

■ 静电袋包装





#### 焊接 Soldering

焊接过程中的不慎操作将会引起产品的损坏,请务必注意。焊接过程中应避免对产品支架或封装部分施加 压力。焊接时,请保证焊接位置与封装树脂底部有一定的距离,该距离因不同的焊接方法而有所不同,请 参照以下推荐焊接条件。

Damages may be caused during soldering, please be careful. Please note that don't put stress on product bracket or package part when soldering. And make sure keep some distance from soldering joint to the bottom of epoxy package when soldering. The distance is determined by different soldering techniques, it's recommended to take following soldering conditions as reference.

#### 推荐焊接条件 Recommended Soldering Conditions

| 焊接模式 Mode                    |                                       | 固定形式 Fixed form  |  |  |
|------------------------------|---------------------------------------|--|--|--|
|                              | 烙铁温度<br>Soldering Iron<br>Temperature | 最高温度 300℃(功率最大 30 瓦)<br>300℃ Max(30w Max)                    |  |  |
| 手工焊接<br>Manually Soldering   | 焊接时间<br>Soldering Time                | 时间不超过 3 秒<br>3 sec Max                                       |  |  |
|                              | 焊接位置<br>Soldering Position            | 大于 3mm (从焊点到胶体)<br>3mm Min.(Form soldering joint to colloid) |  |  |
|                              | 预热<br>Preheat                         | 最高温度 100℃ 不超过 60 秒<br>100℃ Max.60 sec.Max                    |  |  |
| 波峰焊接<br>Wave Soldering       | 温度<br>Temperature                     | 最高 260℃<br>260℃ Max.   |  |  |
|                              | 焊接时间<br>Soldering Time                | 不超过 5 秒<br>5 sec Max   |  |  |
|                              | 预热<br>Preheat                         | 最高温度 100℃ 不超过 60 秒<br>100℃ Max.60 sec.Max                    |  |  |
| 锡炉焊接<br>Solder pot Soldering | 浸焊温度<br>Preheat Temperature           | 最高 260℃<br>260℃ Max.   |  |  |
|                              | 浸焊时间<br>Soldering Time                | 不超过 5 秒<br>5 sec Max   |  |  |
|                              | 焊接位置<br>Soldering Position            | 大于 2mm (从焊点到胶体)<br>2mm Min.(From soldering joint to colloid) |  |  |

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● 本产品不适合做回流焊接。

It's unsuitable for reflow soldering.

• 手工焊接只可焊接一次。

Manually soldering should be done once only

■ 器件外部温度在 40℃以下时,才可以对其进行处理。避免高温时操作对 LED 造成损伤。

Please solder the LED under 40 degree to avoid high temperature damage the device

• 在焊接温度回到正常以前,必须避免使 LED 受到任何震动或外力

After soldering the LED ,please keep it out of any shake or outer force before it come to normal temperature

● 在焊接后推荐使用酒精进行清洗,在温度不高于 30℃的条件下持续 1 分钟,不高于 50℃的条件下持续 30 秒。使用 其他类似溶剂清洗前,请先确认使用的溶剂不会对 LED 的封装和环氧树脂部分造成损伤。

It is recommended that to use alcohol clean LED after soldering. Cleaning should be done under  $30^{\circ}$ C for 1 minute or  $50^{\circ}$ C for 30 seconds. When using other solvents, please confirm whether the solvents would dissolve the package or resin beforehand.

注意:此一般指导原则并不适用于所有 PCB 设计和焊接设备的配置。具体工艺受到诸多因素的影响,请根据特定的 PCB 设计和焊接设备来确定焊接方案。

Note : This general guideline may not suitable for all PCB designs or all soldering equipment configurations. The technique in practice is influenced by many factors. Please confirm soldering method by the PCB designs and configurations.

#### 使用注意事项 Precautions

感谢您使用鑫永诚光电的 LED 系列产品,为增进您对我司产品特性的了解,也为方便您快速掌握产品的基本操作,为尽量减少或避免因人为等因素造成不必要的产品损坏,使其能够更好的为您的生产服务,特针对使用过程中的一些规范使用作相应说明,同时即使是同一规格 LED,在实际应用时其可靠性与客户电路设计、作业方式、使用条件均相关。本使用说明不可能涵盖客户使用过程中可能碰到的所有问题,由此带来的不便,敬请谅解!

Thanks for using relevant LED products of Newopto Photoelectric Technology Co., Ltd. In order to enhance your understanding of the characteristics of our products, as far as reduce and avoid unnecessary damage of product due to man made factors ,and make the product serve your production better , we provide corresponding operation standard instructions . At the same time, even if you are using the same specifications LED, its reliability is related to your circuit design ,mode of operation and conditions of use . This Instructions didn' t cover all questions that customers may encounter during using, we sincerely apologize for any inconvenience this may cause !

- 产品声明 Product Declaration
  - 使用本产品之前,请贵司务必预先进行测试,以便确认是否适合使用目的,产品介绍的用途并不保证不抵触任何专利,有关LED产品的进出口法律责任应由客户担负,请预先查清每个国家或地区的有关规定。产品可能会因性能提升而更改物料和规格参数,恕不另行通知。

In order to confirm the product is right for using purpose, pretest is necessary before use. We don't guarantee the product application introduction don't contravene any patent. The corresponding import and export legal responsibility should be taken by customers. Please verify relevant provision about the LED product in each country and district beforehand. We may change material and specifications from time to time in the interest of product development, without prior notification or public announcement.

- 储存 Storage
  - 在温度不高于 30℃, 湿度不高于 60%RH 的条件下,产品保存期限为 6 个月。将产品保存在密封的容器中并附带干燥剂可以在一定程度上延续产品的储存日期。不良的储存条件会导致产品引脚的腐蚀或产品性能的改变。

Under the storage conditions of 30°C or less and humidity less than 60%RH, the storage period of LED is 6months. Store the products in sealed container with moisture absorbent material could prolong the storage time to a certain extent. Bad storage conditions may cause the LED pin corrode or LED characteristics be changed. It is recommended that the LEDs be used as soon as possible.

 开封后,产品必须48小时内使用完(建议工作环境温度不高于30℃,湿度不高于60%),如未使用完,余料须存 放在温度不高于30℃,湿度不高于10%的环境中,以免引脚生锈。

After opening package, the product should be soldered within 48 hours. If not, please store at  $30^{\circ}$ C or less and humidity less than  $10^{\circ}$ RH. It is recommended that the product be operated at the workshop condition of  $30^{\circ}$ C or less and humidity less than  $60^{\circ}$ RH, to keep the pins of product from rusting.

● 对于尚未焊接的 LED,如果吸湿剂或包装失效、或者产品没有符合以上有效存储条件,而引脚未变色生锈,建议将 产品裸放在 100℃条件下烘烤至少 10 小时后再使用。

For the LED doesn't solder ,if the moisture absorbent material lose efficacy or the storage condition doesn't



conform to the above description, and the feet of the product is not discolour or rust, you can use it after baking it without package at condition : 100±5°C for 10 hours less.

#### ■ 静电 Static electricity

静电和电涌会导致产品特性发生改变,例如正向电压降低等,如果情况严重甚至会损毁产品,所以在使用时必须采取有效的防静电措施。所有相关的设备和机器都应该正确的接地,同时必须采取其他防静电和电涌的措施。使用防静电手环,防静电垫子,防静电工作服,工作鞋,手套,防静电容器,都是有效的防止静电和电涌的措施。

Static and electric surge would change the features of LED, such as decreasing of forward voltage. Even damages may occur in serious conditions. Please make sure adopt effective anti-static measures. All the relative devices and machinery must be properly grounded. At the same time, it is recommended to use anti-static wrist bands, anti-electrostatic gloves, anti-electrostatic containers and so on to prevent static and electric surge.

#### ■ 设计建议 Design Consideration

• 设计电路时,通过 LED 的电流不能超过规定的最大值,同时还需要使用保护电阻,否则微小的电压变化将会引起较大的电流变化,可能导致产品损毁。

When design the circuit, the voltage loaded on the both ends of the photosensitive LED tube should not exceed the specified maximum value, and the protect resistance should be used. Otherwise the tiny change of voltage would cause big current change and it may damage the product.

● LED 的特性容易因为自身的发热和环境的温度的改变而发生改变。温度的升高会降低 LED 的发光效率和寿命,所以 在设计时应充分考虑散热的问题。

The characteristics of LED are easily to be effected by the heat of itself and the temperature changes of environment. The temperature increases would reduce the luminous efficiency and life. Please fully consider the heat dissipation when design.

#### ■ 支架整形 Lead Forming

 支架的整形必须在焊接之前进行。整形时,支架的弯曲位置必须至少在封装树脂底部 3mm 处,同时避免对同一位置 进行多次的弯曲。

Any lead forming must be done before soldering. When forming leads ,the leads should be bent at least 3mm from the base of the expose bulb. And avoid bending twice or even more at the same position.

整形时请使用合适的工具固定支架,避免对树脂施加压力。特别是不能管脚与树脂的连接部分作为支点,这样产生的应力会直接对产品内部的发光结构造成损伤,导致产品特性的改变甚至损毁。

Please use proper tools to hold the leads. Avoid put press on resin especially don't regard connection part of pin and resin as fulcrum, the pressure caused by it would damage the inner part of product illumination structure, and would change the characters or even damage of the product.

• 基于同样的原因,在装配产品的时候, PCB板上焊孔间的距离必须与产品的管脚间距严格匹配。

For the same reason, when mounting the LED on to printed circuit board, the holes on the circuit board should be exactly aligned with the leads of the LED.